



# **SEMICON®** Europa 2016

25-27 October, 2016 Alpexpo, Grenoble, France

## 2016 Highlights

- Largest Semiconductor Event in Europe: Nearly 4,000 industry experts, professionals and executives in attendance
- SEMICON Europa 2016 Executive Keynote Speakers:
  - Maxine Fassberg, CEO, Intel Israel
  - Dr. Rutger Wijburg, Sr. Vice President and General Manager, GLOBALFOUNDRIES Dresden
  - Jean René Lèquepeys, Head of the Silicon Components Division, Leti
- More than 250 Speakers in More than 40 Conferences, Sessions and Workshops, Including:
  - Fab Management Forum
  - Advanced Packaging Conference
  - 2016FLEX Europe Conference
  - Imaging Conference
  - Power Electronic Conference
- More than 40 Media Partners, 30 Supporting Institutions
- More than 1,000 Program and Conference Attendees
- Co-located IoT Planet event attracted more than 2,000 visitors

#### **Attendance**

Total Attendance (Visitors and Exhibitors)	3,651
Verified Visitors	2,196
Verified Exhibitors	1,455

#### **Exhibitor Information**

Total SEMICON Exhibiting Companies	296
Net Exhibit Area (sqm)	3,795



#### **Top Visiting Companies**

- **ABB Semiconductor**
- Air Liquide
- ams AG
- **Applied Materials**
- ARM
- **ASM Europe**
- ASML Bosch Sensortec
- **Brooks Automation**
- Canon Capital-E
- CFA Investissement
- Centrotherm
- CERN
- CISCO
- CMOSIS Belgium
- Crocus Nano Electronics
- Cypress Semiconductor Dow Chemical
- Dupont
- e2v
- EDF ENR PWT Epcos OHG
- First Sensor Microelectronic Packaging
- Fraunhofer
- Global Foundries Dresden
- Huawei
- IBM IHP
- imec
- Infineon
- Intel
- JSR Micro NV
- Kalray
- KLA-Tencor
- LAAS-CNRS
- Lam Research
- LETI
- Lfoundry
- Linde Electronics
- Melexis

- memsfab GmbH Memsstar Limited
- Merck
- MICRONAS GmbH
- MICROOLED SAS
- Mikron
- NANIUM
- **NXP Semiconductors**
- ON Semiconductor
- **OSRAM Opto**
- Semiconductors 5 Panasonic
- Panasonic Automotive Philips
- Philips Innovation
- Services
- Robert Bosch GmbH
- Saint-Gobain
- Samsung Electronics
- Samsung Semiconductor Europe GmbH
- Samsung Ventures Europe
- Schneider Electric Sensata Technologies
- Sensirion AG
- Siemens AG
- Siemens Industry Software GmbH
- Silex Microsystems Siltronic
- SOITEC
- Sony
- STMicroelectronics
- TDK
- Tokyo Electron Texas Instruments
- Toshiba
- Toyota Motor Europe **Tronics Microsystems**
- Trymax Semiconductor B.V.
- Umicore
- Valeo
- Vishay
- X-FAB AG

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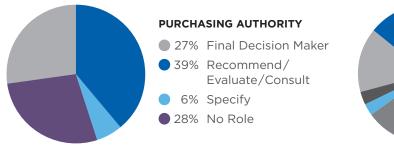


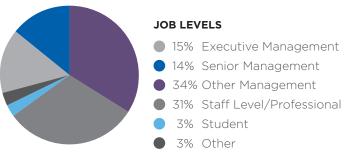
### Visitor Profile

SEMICON Europa attracts a highly influential audience from every segment and sector of the European microelectronics industries, including semiconductors, solar / PV, LEDs, MEMS, printed / organic / flexible, and other adjacent markets.

#### **Influential Buyers**

More than 70% of SEMICON Europa visitors are involved in purchasing decisions, influencing the selection and final purchase of microelectronics manufacturing equipment, materials, software, and services.





#### **Primary Job Functions**

Research and Development Engineering	13%
Fabrication and Process Engineering	6%
Manufacturing Engineering/Operations Management	6%
Product Management/Engineering	6%
Design Engineering (incl. Software, Systems, Test, Hardware)	4%
Facilities Engineering/Engineering Support	3%
Assembly/Packaging Engineering	2%
<b>Quality Assurance and Test Engineering/Standards</b>	1%
Chemical Engineering	<1%
Marketing, Sales, Business Development	23%
Executive Management/Board Member	16%
Manufacturing and Production	4%
Purchasing/Procurement	4%
Government/Public Policy/Investor Relations	2%
Financial/Industry Analyst	1%
Financial/Industry Analyst  Human Resources	1% 1%
	170
Human Resources	1%

41% visitors represent engineering and product management job functions,

13% visitors focus on research and development







## Areas of Interest

SEMICON Europa visitors are interested in a broad range of industries, technologies, and products from across the supply chain, from design to final manufacturing.

#### **Areas of Interest**

**MANUFACTURING** 

Semiconductor Device Manufacturing (IDM, foundry)	50%
Electronic Manufacturing Services	31%
MEMS Manufacturing Packaging, Assembly and Test Services LED Manufacturing Fabless Semiconductor Manufacturing Photovoltaic Manufacturing	30%
	30%
	20%
	18%
	17%
MANUFACTURING EQUIPMENT	
Wafer Processing/Front-end Manufacturing Equipment	41%
Inspection and Measurement/Metrology	22%
MEMS Manufacturing Equipment	22%
Test Equipment (Device)	22%
Assembly and Packaging Equipment	20%
Clean Room/Lab Equipment	20%
Material Handling Equipment	16%
LED Manufacturing Equipment	13%
Factory Automation/Robotics	12%
Display Manufacturing Equipment	11%
Test Equipment (Environmental)	11%
Printing, Coating, Roll-to-Roll Equipment	10%
MATERIALS	
Wafer and Related Substrates	28%
Process Chemicals	19%
Assembly and Packaging Materials	16%
MEMS Materials	16%
Photolithography Materials	15%
Deposition Materials	14%
Gases and Liquid Chemicals	14%
Consumables (Test and Process)	13%
Clean Room Supplies	129
LED Materials	119
PV/Solar Cells and Modules	9%
Inks, Pastes and Printing Materials	7%
SUB-SYSTEMS/COMPONENTS/SOFTWARE	
Manufacturing/Factory Automation	13%
Factory Control Automation/Facilities	10%
Electronic Design Automation	9%

#### **Microelectronic Device Interests**

MEMS/Sensor Components	18%
Integrated Circuit (IC) Logic	17%
Analog/Power Semiconductor	14%
Integrated Circuit (IC) Memory	13%
LED Components	11%
Integrated Systems	10%
Flexible, Hybrid, Plastic Electronics	9%
Batteries	8%
Displays	8%
Electronic Design Automation (EDA)	7%

#### **Systems and Applications Interests**

Automotive	22%
Industrial	21%
Consumer Electronics/Wearables	18%
Sensing	17%
Energy/Power	16%
Communications	16%
Imaging	16%
Healthcare/Biotechnology/Wellness	15%
PC/Computer/Tablet/Storage	15%
Security	12%



9% 8%

7%

6%

6%

6%



**Sub-systems** 

**Support Products** (including Consumables)

**Secondary Equipment and Services** 

**SERVICES/SUPPORT PRODUCTS** 

**General Business Services/Consulting** 

**Silicon Intellectual Property** 

**Manufacturing Services and Consulting** (Directly related to mfg.)